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324	755	Class	Subclass	ISSUE CLASSIFICATION
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PC

PATENT NUMBER

U.S. UTILITY Patent Application

SCANNED	O.I.P.E.	PATENT DATE
PC1	UB	

APPLICATION NO.	CONT/PRIOR	CLASS	SUBCLASS	ART UNIT	EXAMINER
09/827248	D	324	755	2858 2829	Buyer, Vinay

APPLICANTS: David Hembree

TITLE: Methods of processing wafers and methods of communicating signals with respect to a wafer

PTO-2040
12/89

ISSUING CLASSIFICATION			
ORIGINAL		CROSS REFERENCE(S)	
CLASS	SUBCLASS	CLASS	SUBCLASS (ONE CLASS EACH REFERENCE)
324	755	324	755
INTERNATIONAL CLASSIFICATION			
324		3110	

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	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
	(Assistant Examiner) _____ (Date) _____			NOTICE OF ALLOWANCE MAILED	
	(Primary Examiner) _____ (Date) _____			ISSUE FEE	
	(Legal Instruments Examiner) _____ (Date) _____			Amount Due	Date Paid
			ISSUE BATCH NUMBER		

Form PTO-403A
(Rev. 6-89)

FILED WITH: ☐ DISC/APP ☐ DISC/APP ☐ DISC/APP